

Title (en)
IMAGE SENSOR MODULE AND METHOD FOR PRODUCING SUCH A MODULE

Title (de)
BILDSSENSOR-MODUL UND VERFAHREN ZUM HERSTELLEN EINES SOLCHEN

Title (fr)
MODULE DE CAPTEUR D'IMAGE ET PROCÉDÉ DE FABRICATION DUDIT MODULE DE CAPTEUR D'IMAGE

Publication
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Application
EP 12700398 A 20120116

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Abstract (en)
[origin: WO2012123142A1] The invention relates to an image sensor module comprising an image sensor carrier and an image sensor, wherein the image sensor carrier is in the form of an injection-moulded circuit carrier, and wherein the image sensor is arranged on the image sensor carrier, and wherein the image sensor carrier comprises at least one holding means integrally formed on the image sensor carrier. The invention likewise relates to a method for producing an image sensor module and to a use.

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H04N 5/225 (2006.01)

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Citation (search report)
See references of WO 2012123142A1

Citation (examination)
• US 2010328525 A1 20101230 - LEE SOO-BONG [KR], et al
• JP H0996749 A 19970408 - FUJI PHOTO OPTICAL CO LTD
• US 2006186317 A1 20060824 - FARNWORTH WARREN M [US], et al

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